RD15HVF1
RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz-520MHz, 15W

DESCRIPTION
RD15HVF1 is a MOS FET type transistor specifically designed for VHF/UHF High power amplifiers applications.

FEATURES
High power and High Gain:
- Pout > 15W, Gp > 14dB @ Vdd = 12.5V, f = 175MHz
- Pout > 15W, Gp > 7dB @ Vdd = 12.5V, f = 520MHz
High Efficiency: 60% typ. on VHF Band
High Efficiency: 55% typ. on UHF Band

APPLICATION
For output stage of high power amplifiers in VHF/UHF Band mobile radio sets.

RoHS COMPLIANT
RD15HVF1-101 is a RoHS compliant products.
RoHS compliance is indicate by the letter “G” after the lot marking.
This product include the lead in high melting temperature type solders.
However, it is applicable to the following exceptions of RoHS Directions.
- 1. Lead in high melting temperature type solders (i.e. tin-lead solder alloys containing more than 85% lead.)
## ABSOLUTE MAXIMUM RATINGS

(Tc=25°C UNLESS OTHERWISE NOTED)

<table>
<thead>
<tr>
<th>SYMBOL</th>
<th>PARAMETER</th>
<th>CONDITIONS</th>
<th>RATINGS</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>VDSS</td>
<td>Drain to source voltage</td>
<td>Vgs=0V</td>
<td>30</td>
<td>V</td>
</tr>
<tr>
<td>VGSS</td>
<td>Gate to source voltage</td>
<td>Vds=0V</td>
<td>+/-20</td>
<td>V</td>
</tr>
<tr>
<td>Pch</td>
<td>Channel dissipation</td>
<td>Tc=25°C</td>
<td>48</td>
<td>W</td>
</tr>
<tr>
<td>Pin</td>
<td>Input power</td>
<td>Zg=Zl=50Ω</td>
<td>1.5(Note2)</td>
<td>W</td>
</tr>
<tr>
<td>ID</td>
<td>Drain current</td>
<td></td>
<td>4</td>
<td>A</td>
</tr>
<tr>
<td>Tch</td>
<td>Channel temperature</td>
<td></td>
<td>150</td>
<td>°C</td>
</tr>
<tr>
<td>Tstg</td>
<td>Storage temperature</td>
<td></td>
<td>-40 to +150</td>
<td>°C</td>
</tr>
<tr>
<td>Rth j-c</td>
<td>Thermal resistance</td>
<td>junction to case</td>
<td>2.6</td>
<td>°C/W</td>
</tr>
</tbody>
</table>

Note 1: Above parameters are guaranteed independently.

Note 2: Over 300MHz use spec is 6W

## ELECTRICAL CHARACTERISTICS

(Tc=25°C, UNLESS OTHERWISE NOTED)

<table>
<thead>
<tr>
<th>SYMBOL</th>
<th>PARAMETER</th>
<th>CONDITIONS</th>
<th>LIMITS</th>
<th>UNIT</th>
</tr>
</thead>
<tbody>
<tr>
<td>IDSS</td>
<td>Zero gate voltage drain current</td>
<td>Vds=17V, Vgs=0V</td>
<td>-</td>
<td>100</td>
</tr>
<tr>
<td>IGSS</td>
<td>Gate to source leak current</td>
<td>Vgs=10V, Vds=0V</td>
<td>-</td>
<td>1</td>
</tr>
<tr>
<td>VTH</td>
<td>Gate threshold Voltage</td>
<td>Vds=12V, Is=1mA</td>
<td>1.5</td>
<td>2.0</td>
</tr>
<tr>
<td>Pout1</td>
<td>Output power</td>
<td>VDD=12.5V, Pin=0.6W, f=175MHz, Idq=0.5A</td>
<td>15</td>
<td>18</td>
</tr>
<tr>
<td>ηD1</td>
<td>Drain efficiency</td>
<td>f=175MHz, Idq=0.5A</td>
<td>55</td>
<td>60</td>
</tr>
<tr>
<td>Pout2</td>
<td>Output power</td>
<td>VDD=12.5V, Pin=3W, f=520MHz, Idq=0.5A</td>
<td>15</td>
<td>18</td>
</tr>
<tr>
<td>ηD2</td>
<td>Drain efficiency</td>
<td>f=520MHz, Idq=0.5A</td>
<td>50</td>
<td>55</td>
</tr>
<tr>
<td>Load VSWR tolerance</td>
<td>VDD=15.2V, Po=15W(PinControl) f=175MHz, Idq=0.5A, Zg=50Ω, Load VSWR=20:1(All Phase)</td>
<td>No destroy</td>
<td>-</td>
<td></td>
</tr>
<tr>
<td>Load VSWR tolerance</td>
<td>VDD=15.2V, Po=15W(PinControl) f=520MHz, Idq=0.5A, Zg=50Ω, Load VSWR=20:1(All Phase)</td>
<td>No destroy</td>
<td>-</td>
<td></td>
</tr>
</tbody>
</table>

Note: Above parameters, ratings, limits and conditions are subject to change.
< Silicon RF Power MOS FET (Discrete) >
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TYPICAL CHARACTERISTICS

- CHANNEL DISSIPATION VS. AMBIENT TEMPERATURE
  ![Channel Dissipation vs. Ambient Temperature Graph](image1.png)

- Vgs-Ids CHARACTERISTICS
  ![Vgs-Ids Characteristics Graph](image2.png)

- Vds-Ids CHARACTERISTICS
  ![Vds-Ids Characteristics Graph](image3.png)

- Vds VS. Ciss CHARACTERISTICS
  ![Vds vs. Ciss Characteristics Graph](image4.png)

- Vds VS. Coss CHARACTERISTICS
  ![Vds vs. Coss Characteristics Graph](image5.png)

- Vds VS. Crss CHARACTERISTICS
  ![Vds vs. Crss Characteristics Graph](image6.png)

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TYPICAL CHARACTERISTICS

Pin-Po CHARACTERISTICS

Vdd-Po CHARACTERISTICS

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TYPICAL CHARACTERISTICS

![Graph showing Vgs-Ids characteristics for RD15HVF1 at various temperatures: -25°C, +25°C, +75°C.]

TEST CIRCUIT (f=175MHz)

![Diagram of the test circuit with components labeled for Vgs, Vdd, RF-IN, and RF-OUT, including capacitors L1, L2, L3, C1, C2, and C3, and inductors with various values and dimensions.]

- **C1**: 2200pF in parallel
- **C2**: 2200pF + 10μF in parallel
- **C3**: 2200pF + 330μF in parallel
- **L1**: 4 turns, D1: 6mm, D1: 6mm, P=1 silver plated copper wire
- **L2**: 5 turns, D1: 6mm, D1: 6mm, P=1 silver plated copper wire
- **L3**: 4 turns, D1: 6mm, D1: 6mm, P=1 silver plated copper wire

Note: Board material PTFE substrate
micro strip line width=4.2mm/50OHM, er=2.7, t=1.6mm
Dimensions: mm

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TEST CIRCUIT (f=520MHz)

C1: 2200pF 10μF in parallel
C2: 2200pF*2 in parallel
C3: 2200pF, 330μF in parallel
L1: 4 Turns, I.D 6mm, D1.6mm, P=1 silver plated copper wire
L2: 2 Turns, I.D 6mm, D1.6mm, P=1 silver plated copper wire
L3: 4 Turns, I.D 6mm, D1.6mm, P=1 silver plated copper wire

Note: Board material PTFE substrate
micro strip line width=4.2mm/50Ω, εr=2.7, t=1.6mm
Dimensions: mm

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## INPUT/OUTPUT IMPEDANCE VS. FREQUENCY CHARACTERISTICS

<table>
<thead>
<tr>
<th>( f ) (MHz)</th>
<th>( Z_{in} ) (ohm)</th>
<th>( Z_{out} ) (ohm)</th>
<th>Conditions</th>
</tr>
</thead>
<tbody>
<tr>
<td>175</td>
<td>2.34-j8.01</td>
<td>3.06+j0.74</td>
<td>Po=15W, Vdd=12.5V, Pin=0.6W</td>
</tr>
<tr>
<td>520</td>
<td>5.42+j9.22</td>
<td>6.02+j12.34</td>
<td>Po=15W, Vdd=12.5V, Pin=3.0W</td>
</tr>
</tbody>
</table>

\( Zo=50\,\text{ohm} \)
< Silicon RF Power MOS FET (Discrete) >

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**RD15HVF1 S-PARAMETER DATA (@Vdd=12.5V, Id=500mA)**

<table>
<thead>
<tr>
<th>Freq. [MHz]</th>
<th>S11 (mag)</th>
<th>S11 (ang)</th>
<th>S21 (mag)</th>
<th>S21 (ang)</th>
<th>S12 (mag)</th>
<th>S12 (ang)</th>
<th>S22 (mag)</th>
<th>S22 (ang)</th>
</tr>
</thead>
<tbody>
<tr>
<td>50</td>
<td>0.717</td>
<td>-145.9</td>
<td>23.274</td>
<td>101.8</td>
<td>0.023</td>
<td>26.0</td>
<td>0.556</td>
<td>-130.2</td>
</tr>
<tr>
<td>100</td>
<td>0.726</td>
<td>-163.9</td>
<td>12.054</td>
<td>85.7</td>
<td>0.024</td>
<td>27.7</td>
<td>0.547</td>
<td>-150.4</td>
</tr>
<tr>
<td>150</td>
<td>0.744</td>
<td>-171.1</td>
<td>8.049</td>
<td>74.7</td>
<td>0.025</td>
<td>36.1</td>
<td>0.560</td>
<td>-157.8</td>
</tr>
<tr>
<td>175</td>
<td>0.748</td>
<td>-173.6</td>
<td>6.804</td>
<td>70.2</td>
<td>0.025</td>
<td>41.8</td>
<td>0.571</td>
<td>-160.1</td>
</tr>
<tr>
<td>200</td>
<td>0.755</td>
<td>-175.9</td>
<td>5.886</td>
<td>66.3</td>
<td>0.026</td>
<td>48.1</td>
<td>0.588</td>
<td>-161.8</td>
</tr>
<tr>
<td>250</td>
<td>0.770</td>
<td>-179.0</td>
<td>4.622</td>
<td>58.6</td>
<td>0.030</td>
<td>57.7</td>
<td>0.625</td>
<td>-164.3</td>
</tr>
<tr>
<td>300</td>
<td>0.787</td>
<td>177.6</td>
<td>3.731</td>
<td>51.5</td>
<td>0.036</td>
<td>65.3</td>
<td>0.647</td>
<td>-167.5</td>
</tr>
<tr>
<td>350</td>
<td>0.804</td>
<td>174.6</td>
<td>3.092</td>
<td>45.3</td>
<td>0.044</td>
<td>70.3</td>
<td>0.683</td>
<td>-170.9</td>
</tr>
<tr>
<td>400</td>
<td>0.821</td>
<td>171.2</td>
<td>2.623</td>
<td>39.1</td>
<td>0.053</td>
<td>73.5</td>
<td>0.716</td>
<td>-173.7</td>
</tr>
<tr>
<td>450</td>
<td>0.838</td>
<td>168.2</td>
<td>2.229</td>
<td>33.2</td>
<td>0.062</td>
<td>74.6</td>
<td>0.734</td>
<td>-176.8</td>
</tr>
<tr>
<td>500</td>
<td>0.849</td>
<td>165.1</td>
<td>1.938</td>
<td>28.3</td>
<td>0.072</td>
<td>73.9</td>
<td>0.765</td>
<td>-179.4</td>
</tr>
<tr>
<td>520</td>
<td>0.854</td>
<td>163.7</td>
<td>1.845</td>
<td>26.1</td>
<td>0.076</td>
<td>73.9</td>
<td>0.777</td>
<td>-178.0</td>
</tr>
<tr>
<td>550</td>
<td>0.862</td>
<td>161.7</td>
<td>1.695</td>
<td>22.9</td>
<td>0.082</td>
<td>72.6</td>
<td>0.788</td>
<td>-176.3</td>
</tr>
<tr>
<td>600</td>
<td>0.876</td>
<td>155.0</td>
<td>0.971</td>
<td>4.2</td>
<td>0.135</td>
<td>62.8</td>
<td>0.859</td>
<td>-159.0</td>
</tr>
<tr>
<td>650</td>
<td>0.880</td>
<td>143.2</td>
<td>0.684</td>
<td>0.0</td>
<td>0.143</td>
<td>59.6</td>
<td>0.870</td>
<td>-155.7</td>
</tr>
<tr>
<td>700</td>
<td>0.892</td>
<td>131.2</td>
<td>0.453</td>
<td>-1.4</td>
<td>0.153</td>
<td>57.8</td>
<td>0.877</td>
<td>-152.4</td>
</tr>
<tr>
<td>750</td>
<td>0.907</td>
<td>131.2</td>
<td>0.462</td>
<td>-1.8</td>
<td>0.163</td>
<td>54.8</td>
<td>0.880</td>
<td>-149.0</td>
</tr>
<tr>
<td>800</td>
<td>0.912</td>
<td>127.5</td>
<td>0.612</td>
<td>-3.4</td>
<td>0.170</td>
<td>51.4</td>
<td>0.886</td>
<td>-145.7</td>
</tr>
</tbody>
</table>

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ATTENTION:
1. High Temperature; This product might have a heat generation while operation. Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product, do not place the combustible material that have possibilities to arise the fire.
2. Generation of High Frequency Power; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
3. Before use; Before use the product, Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:
1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
2. RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and in the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products, please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.
3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C (in case of Tchmax=150deg/C), 140deg/C (in case of Tchmax=175deg/C) under standard conditions.
6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it’s original form.
9. For additional “Safety first” in your circuit design and notes regarding the materials, please refer the last page of this data sheet.
10. Please refer to the additional precautions in the formal specification sheet.
Keep safety first in your circuit designs!

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